

RoHS

COMPLIANT

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
30	0.008 at V _{GS} = 10 V	13	6.1 nC		
30	0.011 at V _{GS} = 4.5 V	11	0.1110		

SO-8

Top View

D 8

D

D 6

D 5

S

S

S

G

2

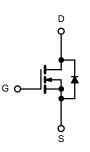
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FEATURES

- Halogen-free
- TrenchFET[®] Power MOSFET
- Optimized for High-Side Synchronous • **Rectifier Operation**
- 100 % Rg Tested
- 100 % UIS Tested ٠

APPLICATIONS

 Notebook CPU Core - High-Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20		
	T _C = 25 °C		13		
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C		10		
Continuous Drain Current (1) = 150°C)	T _A = 25 °C	I _D	9 ^{b, c}		
	T _A = 70 °C	Ι Γ	7 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	45	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	- I _S	3.7		
Continuous Source-Drain Diode Current	T _A = 25 °C		2.0 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	20		
Avalanche Energy		E _{AS}	21	mJ	
	T _C = 25 °C		4.1		
Movimum Dower Dissingtion	T _C = 70 °C	P _D	2.5	w	
Maximum Power Dissipation	T _A = 25 °C	'D	2.2 ^{b, c}	VV	
	T _A = 70 °C	1 [1.3 ^{b, c}		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	39	55	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	25	29	0/11

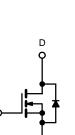
Notes:

a. Base on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 85 °C/W.



SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted								
Symbol	Test Conditions	Min.	Тур.	Max.	Unit			
				-				
-	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V			
$\Delta V_{DS}/T_{J}$	I _р = 250 цА		26		mV/°C			
$\Delta V_{GS(th)}/T_J$	1 <u>0</u> – 200 μ. (- 6					
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.0		3.0	V			
I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA			
I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$			1 10	μA			
I _{D(on)}		20			А			
R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A		0.008		Ω			
06					S			
9fs			50		5			
			800		1			
	(1 - 15)(1) = 0)(1 - 1)				pF			
	$v_{\rm DS} = 15$ v, $v_{\rm GS} = 0$ v, $i = 1$ MHz							
C _{rss}			-					
Q _g	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$			-	nC			
Q _{qs}	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		2.5	10.2				
			2.3					
-	f = 1 MHz	0.36	1.8	3.6	Ω			
			16	23				
t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{1} = 1.4 \Omega$		12	16	-			
t _{d(off)}	$I_D \cong 9 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \Omega$		16	22				
t _f	-		10	18				
t _{d(on)}			8	16	ns			
t _r	V_{DD} = 15 V, R_L = 1.4 Ω		10	20	-			
t _{d(off)}	$I_D \cong 9 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		16	22				
t _f	-		8	15				
ics			•		1			
ا _S	T _C = 25 °C			10				
I _{SM}				50	A			
V _{SD}	I _S = 9 A		0.8	1.2	V			
t _{rr}			15	30	ns			
			6	12	nC			
	ι _F = 9 A, dl/dt = 100 A/μs, Τ _J = 25 °C		8		1			
			7		ns			
	$\begin{tabular}{ c c c c } \hline V_{DS} & $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$	$\begin{tabular}{ c c c c } \hline V_{DS} & V_{GS} = 0 \ V, \ I_{D} = 250 \ \mu A \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A \\ \hline \Delta V_{GS(th)}/T_J & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline V_{CS} = 4.5 \ V, \ I_D = 9 \ A \\ \hline V_{DS} = 15 \ V, \ I_D = 10 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 10 \ A \\ \hline C_{rss} & V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A \\ \hline Q_{gd} & I_D = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 10 \ A \\ \hline Q_{gd} & I_D = 15 \ V, \ R_L = 1.4 \ \Omega \\ \hline I_D \equiv 9 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_f & I_d(off) & I_D = 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \equiv 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline T_f & I_D \equiv 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline T_f & I_D = 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline T_f & I_D = 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline T_f & I_D = 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline T_f & I_D = 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline T_f & I_D = 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline T_f & I_F = 9 \ A, \ dI/dt = 100 \ A/\mu_S, \ T_J = 25 \ ^{\circ}C \\ \hline T_{SM} & I_F = 9 \ A, \ dI/dt = 100 \ A/\mu_S, \ T_J = 25 \ ^{\circ}C \\ \hline T_{SM} & I_F = 9 \ A, \ dI/dt = 100 \ A/\mu_S, \ T_J = 25 \ ^{\circ}C \\ \hline T_{SM} & I_F = 9 \ A, \ dI/dt = 100 \ A/\mu_S, \ T_J = 25 \ ^{\circ}C \\ \hline T_{SM} & I_F = 9 \ A, \ dI/dt = 100 \ A/\mu_S, \ T_J = 25 \ ^{\circ}C \\ \hline T_{SM} & I_F = 9 \ A, \ dI/dt = 100 \ A/\mu_S, \ T_J = 25 \ ^{\circ}C \\ \hline T_{SM} & I_F = 9 \ A, \ dI/dt = 100 \ A/\mu_S, \ T_J = 25 \ ^{\circ}C \ T_{SM} & I_F = 10 \ A/\mu_S \ T_{SM} & I_F \$	$\begin{tabular}{ c c c c c } \hline V_{DS} & V_{GS} = 0 \ V, \ I_{D} = 250 \ \mu A & 30 \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A & 1.0 \\ \hline V_{GS}(th) & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A & 1.0 \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 20 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ I_J = 55 \ ^{\circ}C & V_{DS} = 10 \ V & V_{DS} = 10 \ V, \ I_D = 10 \ A & V_{GS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ I_D = 10 \ A & V_{DS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 15 \ V, \ I_D = 10 \ A & V_{DS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 10 \ V, \ I_D = 10 \ A & V_{DS} = 10 \ V, \ I_D = 10 \ A & V_{DD} = 15 \ V, \ I_D = 10 \ A & V_{DS} = 10 \ V, \ I_D = 10 \ V, \ I$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $			

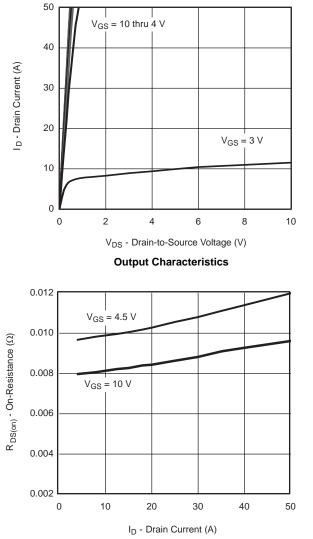
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

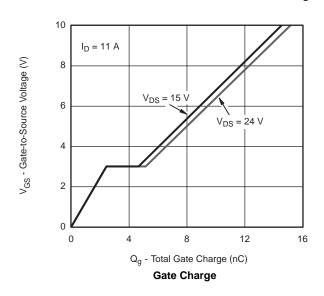
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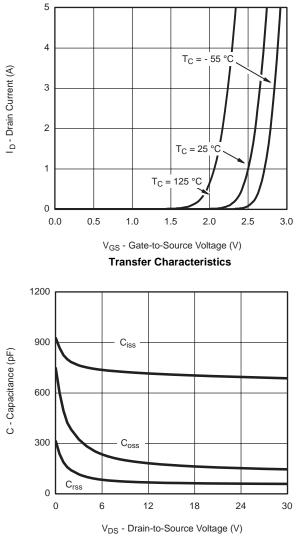


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

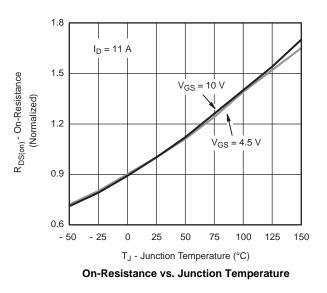


On-Resistance vs. Drain Current and Gate Voltage



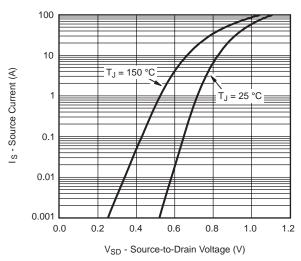


Capacitance

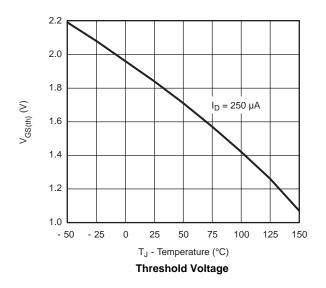


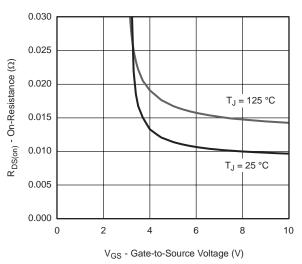


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

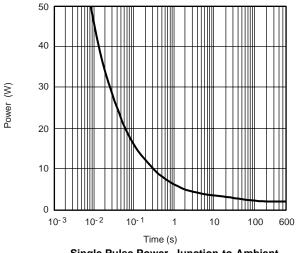




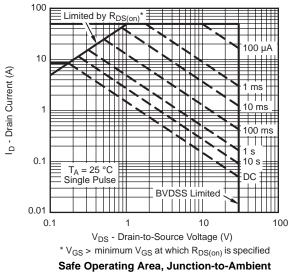




On-Resistance vs. Gate-to-Source Voltage

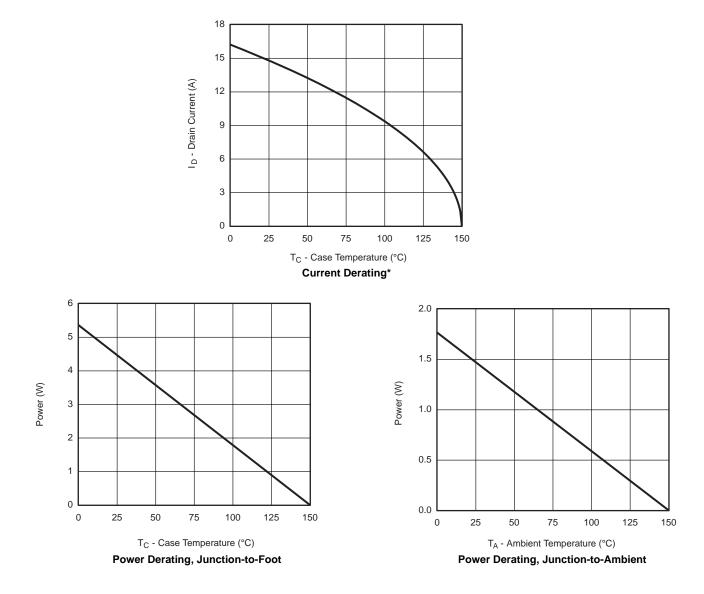


Single Pulse Power, Junction-to-Ambient



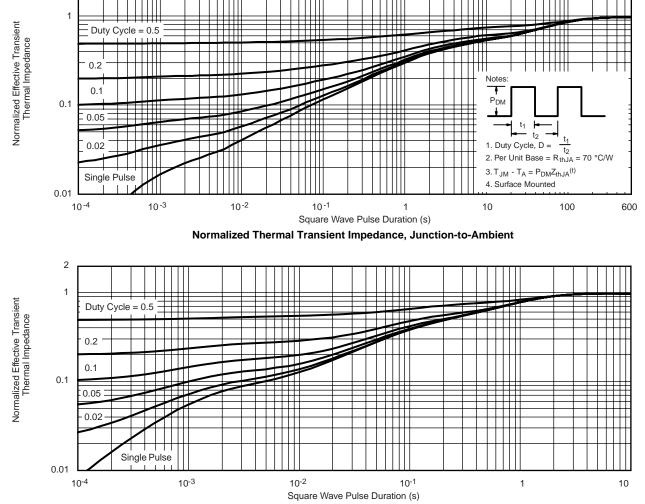


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

2



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

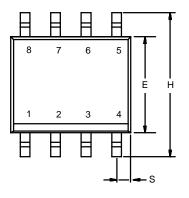
Normalized Thermal Transient Impedance, Junction-to-Foot

Bsemi

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SOIC (NARROW): 8-LEAD

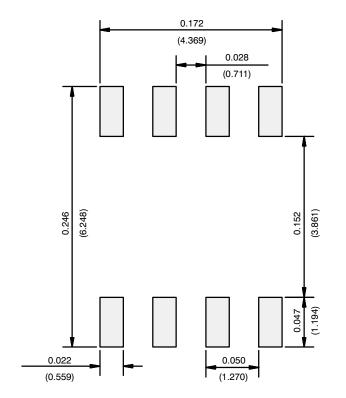




	MILLIMETERS		INC	CHES	
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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